



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Akira MATSUDA et al.**

Group Art Unit: **1775**

Serial Number: **10/719,020**

Examiner: **Robert R. Koehler**

Filed: **November 24, 2003**

Confirmation Number: **9168**

For: **PLATING BATH FOR FORMING THIN RESISTANCE LAYER,  
METHOD OF FORMATION OF RESISTANCE LAYER,  
CONDUCTIVE BASE WITH RESISTANCE LAYER, AND  
CIRCUIT BOARD MATERIAL WITH RESISTANCE LAYER**

Attorney Docket Number: **032130**  
Customer Number: **38834**

**AMENDMENT UNDER 37 CFR §1.111**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

March 10, 2006

Sir:

In response to the Office Action dated September 14, 2005, the response due date extended to March 14, 2006 by a 3-months Extension of Time, please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** begin on page 3 of this paper.

**Remarks** begin on page 8 of this paper.